## onsemi

## 1-of-8 Decoder/ Demultiplexer

## High-Performance Silicon-Gate CMOS

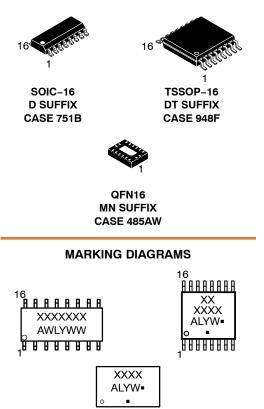
## MC74HC138A, MC74HCT138A

The MC74HC138A/MC74HCT138A is identical in pinout to the LS138. The MC74HC138A inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs. The MC74HCT138A may be used as a level converter for interfacing TTL or NMOS outputs to High Speed CMOS inputs.

The device decodes a three-bit Address to one-of-eight active-low outputs. This device features three Chip Select inputs, two active-low and one active-high to facilitate the demultiplexing, cascading, and chip-selecting functions. The demultiplexing function is accomplished by using the Address inputs to select the desired device output; one of the Chip Selects is used as a data input while the other Chip Selects are held in their active states.

## Features

- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS and TTL
- Operating Voltage Range: 2.0 to 6.0 V (HC), 4.5 to 5.5 V (HCT)
- Low Input Current: 1.0 μA
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance with the Requirements Defined by JEDEC Standard No. 7 A
- Chip Complexity: 122 FETs or 30.5 Equivalent Gates
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable\*
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



| А     | <ul> <li>Assembly Location</li> </ul> |
|-------|---------------------------------------|
| WL, L | = Wafer Lot                           |
| YY, Y | = Year                                |
| WW, W | = Work Week                           |
| ~     |                                       |

G or = Pb-Free Package

(Note: Microdot may be in either location)

**PIN ASSIGNMENT** 

| ao C  |   | 16 | ] v <sub>cc</sub><br>] yo |
|-------|---|----|---------------------------|
| A1 [  | 2 | 15 | D Y0                      |
| A2 [  | 3 | 14 | <b>I</b> Y1               |
| CS2 [ | 4 | 13 | <b>1</b> Y2               |
| сѕз 🛛 | 5 |    | <b>I</b> Y3               |
| CS1 [ | 6 | 11 | <b>1</b> Y4               |
| Y7 🛛  | 7 | 10 | <b>1</b> Y5               |
| GND [ | 8 | 9  | D Y6                      |
|       |   |    |                           |

## \_\_\_\_\_

## ORDERING INFORMATION

See detailed ordering and shipping information on page 7 of this data sheet.

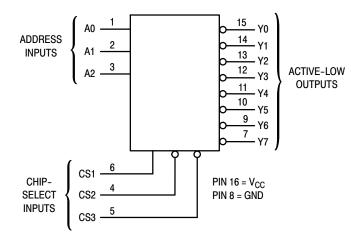


Figure 1. Logic Diagram

**FUNCTION TABLE** 

|     |     | Inp | uts |           |            |    |            |    | Ou | tput       | s  |    |            |
|-----|-----|-----|-----|-----------|------------|----|------------|----|----|------------|----|----|------------|
| CS1 | CS2 | CS3 | A2  | <b>A1</b> | <b>A</b> 0 | Y0 | <b>Y</b> 1 | Y2 | Y3 | <b>Y</b> 4 | Y5 | Y6 | <b>Y</b> 7 |
| Х   | Х   | Н   | Х   | Х         | Х          | Н  | Н          | Н  | Н  | Н          | Н  | Н  | Н          |
| Х   | Н   | Х   | Х   | Х         | Х          | Н  | н          | Н  | Н  | Н          | Н  | Н  | Н          |
| L   | Х   | Х   | Х   | Х         | Х          | Н  | Н          | Н  | Н  | Н          | Н  | Н  | н          |
| Н   | L   | L   | L   | L         | L          | L  | Н          | Н  | Н  | Н          | Н  | Н  | Н          |
| Н   | L   | L   | L   | L         | Н          | Н  | L          | Н  | Н  | Н          | Н  | Н  | Н          |
| Н   | L   | L   | L   | Н         | L          | Н  | Н          | L  | Н  | Н          | Н  | Н  | Н          |
| Н   | L   | L   | L   | Н         | Н          | н  | Н          | Н  | L  | Н          | Н  | Н  | Н          |
| Н   | L   | L   | Н   | L         | L          | Н  | Н          | Н  | Н  | L          | Н  | Н  | Н          |
| Н   | L   | L   | н   | L         | Н          | Н  | н          | Н  | Н  | Н          | L  | Н  | Н          |
| Н   | L   | L   | н   | н         | L          | Н  | н          | Н  | Н  | Н          | Н  | L  | Н          |
| н   | L   | L   | н   | Н         | Н          | н  | Н          | н  | н  | Н          | Н  | Н  | L          |

H = high level (steady state);

L = low level (steady state);

X = don't care

## MAXIMUM RATINGS

| Symbol           | Parameter  |  | Value                    | Unit |
|------------------|--|--|--------------------------|------|
| V <sub>CC</sub>  | DC Supply Voltage  |  | -0.5 to +6.5             | V    |
| V <sub>IN</sub>  | DC Input Voltage   |  | $-0.5$ to $V_{CC}$ + 0.5 | V    |
| V <sub>OUT</sub> | DC Output Voltage  |  | $-0.5$ to $V_{CC}$ + 0.5 | V    |
| I <sub>IN</sub>  | DC Input Current, per Pin  |  | ±20                      | mA   |
| I <sub>OUT</sub> | DC Output Current, per Pin   |  | ±25                      | mA   |
| I <sub>CC</sub>  | DC Supply Current, $V_{CC}$ and GND Pins   |  | ±50                      | mA   |
| Ι <sub>ΙΚ</sub>  | Input Clamp Current ( $V_{IN} < 0$ or $V_{IN} > V_{CC}$ )                          |  | ±20                      | mA   |
| I <sub>OK</sub>  | Output Clamp Current (V <sub>OUT</sub> < 0 or V <sub>OUT</sub> > V <sub>CC</sub> ) |  | ±20                      | mA   |
| T <sub>STG</sub> | Storage Temperature  |  | 65 to +150               | °C   |
| ΤL               | Lead Temperature, 1 mm from Case for 10 Seconds                                    |  | 260                      | °C   |
| TJ               | Junction Temperature Under Bias  |  | ±150                     | °C   |
| $\theta_{JA}$    | Thermal Resistance (Note 1)  | SOIC-16<br>QFN16<br>TSSOP-16             | 126<br>118<br>159        | °C/W |
| P <sub>D</sub>   | Power Dissipation in Still Air at 25°C   | SOIC-16<br>QFN16<br>TSSOP-16             | 995<br>1062<br>787       | mW   |
| MSL              | Moisture Sensitivity   |  | Level 1                  | -    |
| F <sub>R</sub>   | Flammability Rating  | Oxygen Index: 28 to 34                   | UL 94 V-0 @ 0.125 in     | -    |
| V <sub>ESD</sub> | ESD Withstand Voltage (Note 2)   | Human Body Model<br>Charged Device Model | 2000<br>N/A              | V    |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

 Measured with minimum pad spacing on an FR4 board, using 76 mm-by-114 mm, 2-ounce copper trace no air flow per JESD51-7.
 HBM tested to EIA / JESD22-A114-A. CDM tested to JESD22-C101-A. JEDEC recommends that ESD qualification to EIA/JESD22-A115A (Machine Model) be discontinued.

## **RECOMMENDED OPERATING CONDITIONS**

| Symbol                          | Parameter  | Min         | Max                | Unit |
|---------------------------------|--|-------------|--------------------|------|
| MC74HC                          |  |             |                    |      |
| V <sub>CC</sub>                 | DC Supply Voltage  | 2.0         | 6.0                | V    |
| $V_{IN,} V_{OUT}$               | DC Input, Output Voltage (Note 3)  | 0           | V <sub>CC</sub>    | V    |
| T <sub>A</sub>                  | Operating Free-Air Temperature   | -55         | +125               | °C   |
| t <sub>r</sub> , t <sub>f</sub> | Input Rise or Fall Time $V_{CC} = 2.0 \text{ V}$ $V_{CC} = 4.5 \text{ V}$ $V_{CC} = 6.0 \text{ V}$ | 0<br>0<br>0 | 1000<br>500<br>400 | ns   |

#### MC74HCT

| V <sub>CC</sub>                 | DC Supply Voltage                 | 4.5 | 5.5             | V  |
|---------------------------------|-----------------------------------|-----|-----------------|----|
| $V_{\rm IN,}V_{\rm OUT}$        | DC Input, Output Voltage (Note 3) | 0   | V <sub>CC</sub> | V  |
| T <sub>A</sub>                  | Operating Free-Air Temperature    | -55 | +125            | °C |
| t <sub>r</sub> , t <sub>f</sub> | Input Rise or Fall Time           | 0   | 500             | ns |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

3. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V<sub>CC</sub>). Unused outputs must be left open.

|                 |   |  | v <sub>cc</sub>          | Guara                     | nteed Limit               |                           |      |
|-----------------|---|--|--------------------------|---------------------------|---------------------------|---------------------------|------|
| Symbol          | Parameter   | Test Conditions  | V                        | –55°C to 25°C             | ≤ <b>85°C</b>             | ≤125°C                    | Unit |
| V <sub>IH</sub> | Minimum High–Level Input<br>Voltage               | $\begin{array}{l} V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V} \\  I_{out}  \leq 20 \ \mu\text{A} \end{array}$   | 2.0<br>3.0<br>4.5<br>6.0 | 1.5<br>2.1<br>3.15<br>4.2 | 1.5<br>2.1<br>3.15<br>4.2 | 1.5<br>2.1<br>3.15<br>4.2 | V    |
| VIL             | Maximum Low-Level Input<br>Voltage                | $\begin{array}{l} V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V} \\  I_{out}  \leq 20 \ \mu\text{A} \end{array}$   | 2.0<br>3.0<br>4.5<br>6.0 | 0.5<br>0.9<br>1.35<br>1.8 | 0.5<br>0.9<br>1.35<br>1.8 | 0.5<br>0.9<br>1.35<br>1.8 | V    |
| V <sub>OH</sub> | Minimum High–Level Output<br>Voltage              | $\begin{array}{l} V_{in} = V_{IH} \text{ or } V_{IL} \\ \left  I_{out} \right   \leq  20 \; \mu A \end{array}$   | 2.0<br>4.5<br>6.0        | 1.9<br>4.4<br>5.9         | 1.9<br>4.4<br>5.9         | 1.9<br>4.4<br>5.9         | V    |
|                 |   | $\begin{array}{l l} V_{in} = V_{IH} \text{ or } V_{IL} & \left I_{out}\right  \leq 2.4 \text{ mA} \\ \left I_{out}\right  \leq 4.0 \text{ mA} \\ \left I_{out}\right  \leq 5.2 \text{ mA} \end{array}$ | 3.0<br>4.5<br>6.0        | 2.48<br>3.98<br>5.48      | 2.34<br>3.84<br>5.34      | 2.20<br>3.70<br>5.20      |      |
| V <sub>OL</sub> | Maximum Low-Level Output<br>Voltage               | $\begin{array}{l} V_{in} = V_{IH} \text{ or } V_{IL} \\  I_{out}   \leq  20 \; \mu A \end{array}$  | 2.0<br>4.5<br>6.0        | 0.1<br>0.1<br>0.1         | 0.1<br>0.1<br>0.1         | 0.1<br>0.1<br>0.1         | V    |
|                 |   | $\begin{array}{l l} V_{in} = V_{IH} \text{ or } V_{IL} & \left I_{out}\right  \leq 2.4 \text{ mA} \\ \left I_{out}\right  \leq 4.0 \text{ mA} \\ \left I_{out}\right  \leq 5.2 \text{ mA} \end{array}$ | 3.0<br>4.5<br>6.0        | 0.26<br>0.26<br>0.26      | 0.33<br>0.33<br>0.33      | 0.40<br>0.40<br>0.40      |      |
| l <sub>in</sub> | Maximum Input Leakage Cur-<br>rent                | V <sub>in</sub> = V <sub>CC</sub> or GND   | 6.0                      | ±0.1                      | ±1.0                      | ±1.0                      | μΑ   |
| I <sub>CC</sub> | Maximum Quiescent Supply<br>Current (per Package) | $V_{in} = V_{CC} \text{ or } GND$<br>$I_{out} = 0 \ \mu A$   | 6.0                      | 4                         | 40                        | 160                       | μΑ   |

#### DC ELECTRICAL CHARACTERISTICS (MC74HC138A)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

|  |  | Vcc                      | Guara                 |                        |                        |      |
|--|--|--------------------------|-----------------------|------------------------|------------------------|------|
| Symbol                                 | Parameter  | v                        | –55°C to 25°C         | ≤ <b>85°C</b>          | ≤125°C                 | Unit |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay, Input A to Output Y<br>(Figures 2 and 3)    | 2.0<br>3.0<br>4.5<br>6.0 | 135<br>90<br>27<br>23 | 170<br>125<br>34<br>29 | 205<br>165<br>41<br>35 | ns   |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay, CS1 to Output Y<br>(Figures 2 and 4)        | 2.0<br>3.0<br>4.5<br>6.0 | 110<br>85<br>22<br>19 | 140<br>100<br>28<br>24 | 165<br>125<br>33<br>28 | ns   |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay, CS2 or CS3 to Output Y<br>(Figures 2 and 5) | 2.0<br>3.0<br>4.5<br>6.0 | 120<br>90<br>24<br>20 | 150<br>120<br>30<br>26 | 180<br>150<br>36<br>31 | ns   |
| t <sub>TLH</sub> ,<br>t <sub>THL</sub> | Maximum Output Transition Time, Any Output<br>(Figures 2 and 4)        | 2.0<br>3.0<br>4.5<br>6.0 | 75<br>30<br>15<br>13  | 95<br>40<br>19<br>16   | 110<br>55<br>22<br>19  | ns   |
| C <sub>in</sub>                        | Maximum Input Capacitance  | -                        | 10                    | 10                     | 10                     | pF   |

## AC ELECTRICAL CHARACTERISTICS (MC74HC138A)

|                 |  | Typical @ 25°C, V <sub>CC</sub> = 5.0 V |    |
|-----------------|--|---|----|
| C <sub>PD</sub> | Power Dissipation Capacitance (Per Package)* | 55                                      | pF |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. \*Used to determine the no-load dynamic power consumption:  $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$ .

## DC ELECTRICAL CHARACTERISTICS (MC74HCT138A)

|                 |   |   |                      | Gu             | aranteed Li | mit        |      |
|-----------------|---|---|----------------------|----------------|-------------|------------|------|
| Symbol          | Parameter   | Test Conditions   | V <sub>CC</sub><br>V | –55 to<br>25°C | ≤85°C       | ≤125°C     | Unit |
| V <sub>IH</sub> | Minimum High-Level Input<br>Voltage               | $\begin{array}{l} V_{out} = 0.1 \; V \; or \; V_{CC} - 0.1 \; V \\ \left  I_{out} \right  \leq 20 \; \mu A \end{array} \end{array} \label{eq:Vout}$ | 4.5<br>5.5           | 2.0<br>2.0     | 2.0<br>2.0  | 2.0<br>2.0 | V    |
| V <sub>IL</sub> | Maximum Low-Level Input<br>Voltage                | $\begin{array}{l} V_{out} = 0.1 \ V \ or \ V_{CC} - 0.1 \ V \\ \left  I_{out} \right  \leq 20 \ \mu A \end{array}$                                  | 4.5<br>5.5           | 0.8<br>0.8     | 0.8<br>0.8  | 0.8<br>0.8 | V    |
| V <sub>OH</sub> | Minimum High-Level Output<br>Voltage              | V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub><br> I <sub>out</sub>   ≤ 20 μA   | 4.5<br>5.5           | 4.4<br>5.4     | 4.4<br>5.4  | 4.4<br>5.4 | V    |
|                 |   | $V_{in} = V_{IH} \text{ or } V_{IL}$<br>$ I_{out}  \le 4.0 \text{ mA}$  | 4.5                  | 3.98           | 3.84        | 3.7        |      |
| V <sub>OL</sub> | Maximum Low–Level Output<br>Voltage               | V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub><br> I <sub>out</sub>   ≤ 20 μA   | 4.5<br>5.5           | 0.1<br>0.1     | 0.1<br>0.1  | 0.1<br>0.1 | V    |
|                 |   | $V_{in} = V_{IH} \text{ or } V_{IL}$<br>$ I_{out}  \le 4.0 \text{ mA}$  | 4.5                  | 0.26           | 0.33        | 0.4        |      |
| l <sub>in</sub> | Maximum Input Leakage Current                     | V <sub>in</sub> = V <sub>CC</sub> or GND  | 6.0                  | ±0.1           | ±1.0        | ±1.0       | μA   |
| I <sub>CC</sub> | Maximum Quiescent Supply<br>Current (per Package) | $V_{in} = V_{CC} \text{ or } GND$<br>$I_{out} = 0 \ \mu A$  | 5.5                  | 4.0            | 40          | 160        | μΑ   |

|                 | Additional Quiescent Supply | $V_{in}$ = 2.4 V, Any One Input<br>$V_{in}$ = V <sub>CC</sub> or GND, Other Inputs |     | ≥–55°C | 25°C to 125°C |    |
|-----------------|-----------------------------|--|-----|--------|---------------|----|
| $\Delta I_{CC}$ | Current                     | $V_{in} = V_{CC}$ of GND, Other inputs $I_{out} = 0 \ \mu A$                       | 5.5 | 2.9    | 2.4           | mA |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

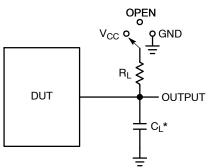
## AC ELECTRICAL CHARACTERISTICS (MC74HCT138A)

|  |   | Gu             | aranteed Li | mit    |      |
|--|---|----------------|-------------|--------|------|
| Symbol                                 | Parameter   | –55 to<br>25°C | ≤85°C       | ≤125°C | Unit |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay, Input A to Output Y<br>(Figures 2 and 3)         | 30             | 38          | 45     | ns   |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay, CS1 to Output Y<br>(Figures 2 and 4)             | 27             | 34          | 41     | ns   |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Output Transition Time, CS2 or CS3 to Output Y<br>(Figures 2 and 5) | 30             | 38          | 45     | ns   |
| t <sub>TLH</sub> ,<br>t <sub>THL</sub> | Maximum Output Transition Time, Any Output<br>(Figures 2 and 4)             | 15             | 19          | 22     | ns   |
| t <sub>r</sub> , t <sub>f</sub>        | Maximum Input Rise and Fall Time  | 500            | 500         | 500    | ns   |
| C <sub>in</sub>                        | Maximum Input Capacitance   | 10             | 10          | 10     | рF   |

|                 |   | Typical @ 25°C, V <sub>CC</sub> = 5.0 V |    |
|-----------------|---|---|----|
| C <sub>PD</sub> | Power Dissipation Capacitance (Per Enabled Output)* | 51                                      | pF |

\*Used to determine the no-load dynamic power consumption:  $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$ .

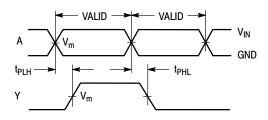
## SWITCHING WAVEFORMS



| Test                                | Switch Position | CL    | RL   |
|-------------------------------------|-----------------|-------|------|
| t <sub>PLH</sub> / t <sub>PHL</sub> | Open            | 50 pF | 1 kΩ |
| t <sub>PLZ</sub> / t <sub>PZL</sub> | V <sub>CC</sub> |       |      |
| t <sub>PHZ</sub> / t <sub>PZH</sub> | GND             |       |      |

 $^{\ast}\text{C}_{\text{L}}$  Includes probe and jig capacitance





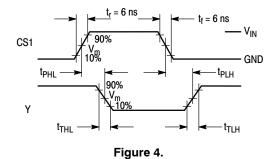


Figure 3.

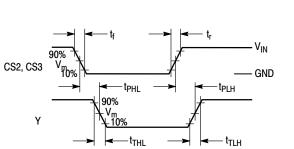


Figure 5.

| Device      | V <sub>IN</sub> , V | V <sub>m</sub> , V    |
|-------------|---------------------|-----------------------|
| MC74HC138A  | V <sub>CC</sub>     | 50% x V <sub>CC</sub> |
| MC74HCT138A | 3 V                 | 1.3 V                 |

## **PIN DESCRIPTIONS**

## ADDRESS INPUTS

## A0, A1, A2 (Pins 1, 2, 3)

Address inputs. These inputs, when the chip is selected, determine which of the eight outputs is active–low.

## **CONTROL INPUTS**

## CS1, CS2, CS3 (Pins 6, 4, 5)

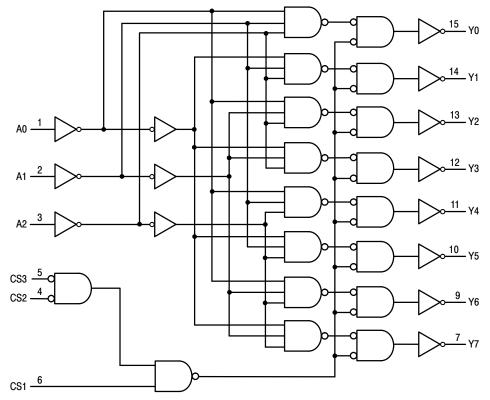
Chip select inputs. For CS1 at a high level and CS2, CS3 at a low level, the chip is selected and the outputs follow the

Address inputs. For any other combination of CS1, CS2, and CS3, the outputs are at a logic high.

## OUTPUTS

## Y0 – Y7 (Pins 15, 14, 13, 12, 11, 10, 9, 7)

Active-low Decoded outputs. These outputs assume a low level when addressed and the chip is selected. These outputs remain high when not addressed or the chip is not selected.



#### Figure 6. Expanded Logic Diagram

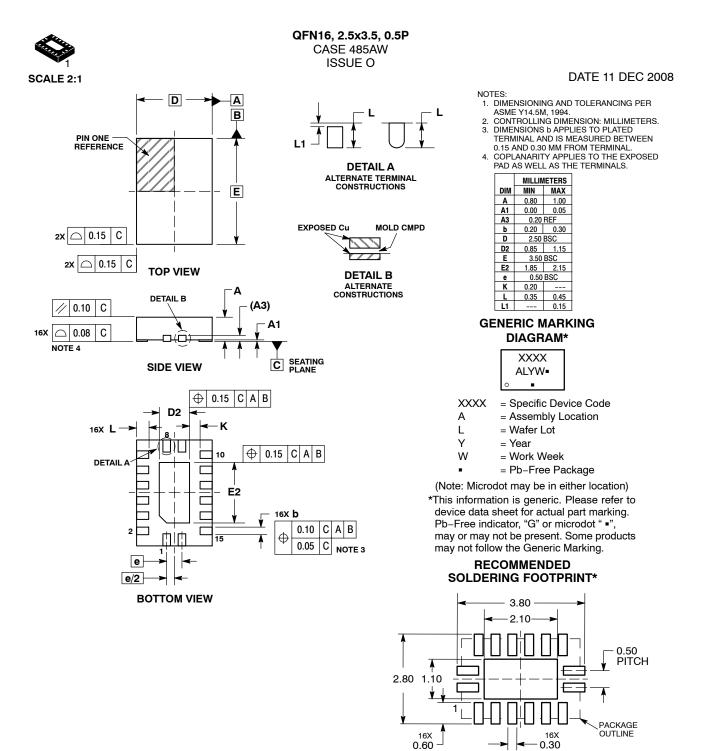
#### ORDERING INFORMATION

| Device             | Marking     | Package  | Shipping <sup>†</sup> |
|--------------------|-------------|----------|-----------------------|
| MC74HC138ADG       | HC138AG     | SOIC-16  | 48 Units / Rail       |
| MC74HC138ADR2G     | HC138AG     | SOIC-16  | 2500 / Tape & Reel    |
| MC74HC138AD2G-Q*   | HC138AG     | SOIC-16  | 2500 / Tape & Reel    |
| MC74HC138ADTR2G    | HC<br>138A  | TSSOP-16 | 2500 / Tape & Reel    |
| MC74HC138ADTR2G-Q* | HC<br>138A  | TSSOP-16 | 2500 / Tape & Reel    |
| MC74HCT138ADR2G    | HCT138AG    | SOIC-16  | 2500 / Tape & Reel    |
| MC74HCT138ADTR2G   | HCT<br>138A | TSSOP-16 | 2500 / Tape & Reel    |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

## PACKAGE DIMENSIONS

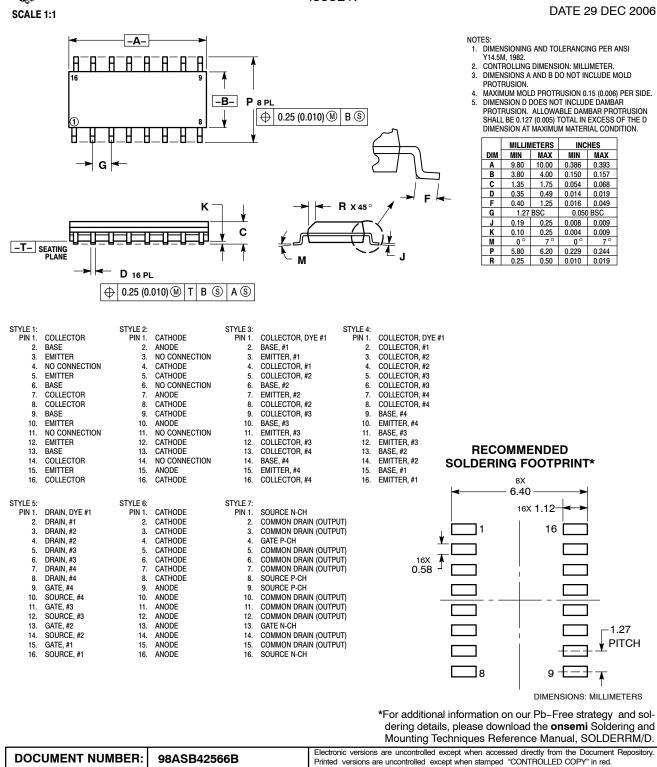


\*For additional information on our Pb–Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DIMENSIONS: MILLIMETERS

# onsemi

SOIC-16 CASE 751B-05 ISSUE K



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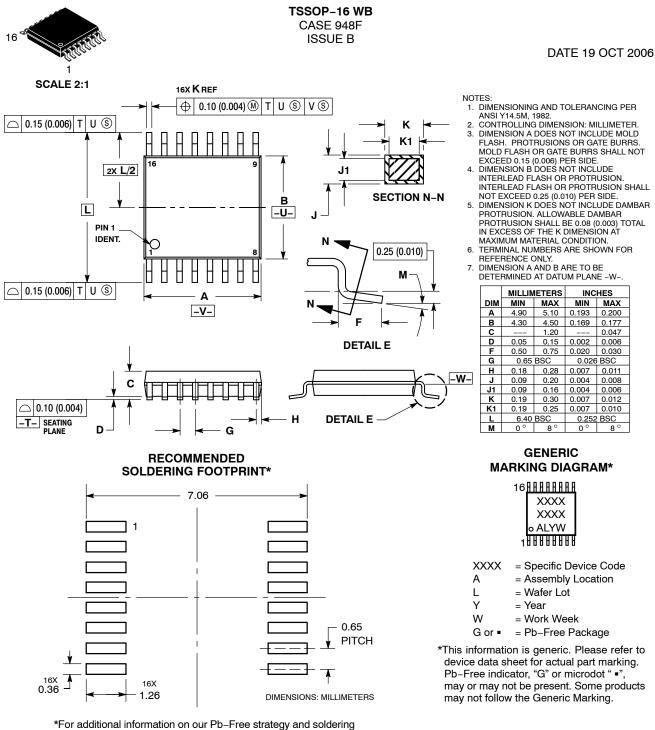
**DESCRIPTION:** 

SOIC-16

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#### MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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